

RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP : RX130
DEVICE : R5F5130XXX
APPLICATION : Consumer / Industry

Quality Assurance Div.
Renesas Electronics Corporation

Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
 2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
 3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
 4. You shall be responsible for determining what licenses are required from any third parties, and obtaining such licenses for the lawful import, export, manufacture, sales, utilization, distribution or other disposal of any products incorporating Renesas Electronics products, if required.
 5. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
 6. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
 "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.
 "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.
 Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.
 7. No semiconductor product is absolutely secure. Notwithstanding any security measures or features that may be implemented in Renesas Electronics hardware or software products, Renesas Electronics shall have absolutely no liability arising out of any vulnerability or security breach, including but not limited to any unauthorized access to or use of a Renesas Electronics product or a system that uses a Renesas Electronics product. RENESAS ELECTRONICS DOES NOT WARRANT OR GUARANTEE THAT RENESAS ELECTRONICS PRODUCTS, OR ANY SYSTEMS CREATED USING RENESAS ELECTRONICS PRODUCTS WILL BE INVULNERABLE OR FREE FROM CORRUPTION, ATTACK, VIRUSES, INTERFERENCE, HACKING, DATA LOSS OR THEFT, OR OTHER SECURITY INTRUSION ("Vulnerability Issues"). RENESAS ELECTRONICS DISCLAIMS ANY AND ALL RESPONSIBILITY OR LIABILITY ARISING FROM OR RELATED TO ANY VULNERABILITY ISSUES. FURTHERMORE, TO THE EXTENT PERMITTED BY APPLICABLE LAW, RENESAS ELECTRONICS DISCLAIMS ANY AND ALL WARRANTIES, EXPRESS OR IMPLIED, WITH RESPECT TO THIS DOCUMENT AND ANY RELATED OR ACCOMPANYING SOFTWARE OR HARDWARE, INCLUDING BUT NOT LIMITED TO THE IMPLIED WARRANTIES OF MERCHANTABILITY, OR FITNESS FOR A PARTICULAR PURPOSE.
 8. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
 9. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
 10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
 11. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
 12. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
 13. This document shall not be reproduced or duplicated in any form or disclosed to any third party, in whole or in part, without prior written consent of Renesas Electronics.
 14. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.
- (Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.
- (Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.5.0-2 October 2020)

Table. Reliability test results (QFP)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 °C, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 °C, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 °C, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 °C to 150 °C , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	+/-1000V,1time	0/3	Class: Equivalent to C2b
Solderability (SD)	J-STD-002	245 °C, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

*1) With preconditioning per JESD22-A113, MSL 3

•It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

Table. Reliability test results (QFN)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 °C, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 °C, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 °C, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 °C to 150 °C , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	+/-1000V,1time	0/3	Class: Equivalent to C2b
Solderability (SD)	J-STD-002	245 °C, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

*1) With preconditioning per JESD22-A113, MSL 3

•It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

The failure rate of the device in an actual use condition can be estimated by the below procedure.

•Equation for the failure rate estimation (λ)

$$\lambda = \lambda_b \times \pi T \text{ (FIT)}$$

①Unique failure rate (λ_b)

$$\lambda_b = 3.8 \text{ FIT}$$

Unique failure rate at $T_a = 55^\circ\text{C}$ using 60 % confidence level.

②Temperature term (πT)

$$\pi T = \exp\{11600 \times E_a \times (1/(273+55) - 1/(273+T_a))\}$$

E_a : Activation energy (eV)

T_a : Ambient temperature ($^\circ\text{C}$)

πT simplified chart as $E_a = 0.7 \text{ eV}$

T_a ($^\circ\text{C}$)	40	50	55	60	65	70	75	80	85	90	100	110
πT	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

•MTTF (Mean Time To Failure)

$$MTTF = 1/\lambda$$

Reference about Renesas package code

Package type		Package code *1
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

*1. First four digit

Table. Product list

No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RX130	R5F51303ADFK	PLQP0064G*	51	RX130	R5F51305BDFP	PLQP0100K*
2	RX130	R5F51303AGFK	PLQP0064G*	52	RX130	R5F51305BGFP	PLQP0100K*
3	RX130	R5F51305ADFK	PLQP0064G*	53	RX130	R5F51306ADFP	PLQP0100K*
4	RX130	R5F51305AGFK	PLQP0064G*	54	RX130	R5F51306AGFP	PLQP0100K*
5	RX130	R5F51306ADFK	PLQP0064G*	55	RX130	R5F51306BDFP	PLQP0100K*
6	RX130	R5F51306AGFK	PLQP0064G*	56	RX130	R5F51306BGFP	PLQP0100K*
7	RX130	R5F51306BDFK	PLQP0064G*	57	RX130	R5F51307ADFP	PLQP0100K*
8	RX130	R5F51306BGFK	PLQP0064G*	58	RX130	R5F51307AGFP	PLQP0100K*
9	RX130	R5F51307ADFK	PLQP0064G*	59	RX130	R5F51308ADFP	PLQP0100K*
10	RX130	R5F51307AGFK	PLQP0064G*	60	RX130	R5F51308AGFP	PLQP0100K*
11	RX130	R5F51308ADFK	PLQP0064G*	61	RX130	R5F51303ADNE	PWQN0048K*
12	RX130	R5F51308AGFK	PLQP0064G*	62	RX130	R5F51303AGNE	PWQN0048K*
13	RX130	R5F51303ADFL	PLQP0048K*	63	RX130	R5F51305ADNE	PWQN0048K*
14	RX130	R5F51303AGFL	PLQP0048K*	64	RX130	R5F51305AGNE	PWQN0048K*
15	RX130	R5F51305ADFL	PLQP0048K*	65	RX130	R5F51306BDNE	PWQN0048K*
16	RX130	R5F51305AGFL	PLQP0048K*	66	RX130	R5F51306BGNE	PWQN0048K*
17	RX130	R5F51306ADFL	PLQP0048K*	67	RX130	R5F51307ADNE	PWQN0048K*
18	RX130	R5F51306AGFL	PLQP0048K*	68	RX130	R5F51307AGNE	PWQN0048K*
19	RX130	R5F51306BDFL	PLQP0048K*	69	RX130	R5F51308ADNE	PWQN0048K*
20	RX130	R5F51306BGFL	PLQP0048K*	70	RX130	R5F51308AGNE	PWQN0048K*
21	RX130	R5F51307ADFL	PLQP0048K*	71			
22	RX130	R5F51307AGFL	PLQP0048K*	72			
23	RX130	R5F51308ADFL	PLQP0048K*	73			
24	RX130	R5F51308AGFL	PLQP0048K*	74			
25	RX130	R5F51303ADFM	PLQP0064K*	75			
26	RX130	R5F51303AGFM	PLQP0064K*	76			
27	RX130	R5F51305ADFM	PLQP0064K*	77			
28	RX130	R5F51305AGFM	PLQP0064K*	78			
29	RX130	R5F51306ADFM	PLQP0064K*	79			
30	RX130	R5F51306AGFM	PLQP0064K*	80			
31	RX130	R5F51306BDFM	PLQP0064K*	81			
32	RX130	R5F51306BGFM	PLQP0064K*	82			
33	RX130	R5F51307ADFM	PLQP0064K*	83			
34	RX130	R5F51307AGFM	PLQP0064K*	84			
35	RX130	R5F51308ADFM	PLQP0064K*	85			
36	RX130	R5F51308AGFM	PLQP0064K*	86			
37	RX130	R5F51303ADFN	PLQP0080K*	87			
38	RX130	R5F51303AGFN	PLQP0080K*	88			
39	RX130	R5F51305ADFN	PLQP0080K*	89			
40	RX130	R5F51305AGFN	PLQP0080K*	90			
41	RX130	R5F51306ADFN	PLQP0080K*	91			
42	RX130	R5F51306AGFN	PLQP0080K*	92			
43	RX130	R5F51306BDFN	PLQP0080K*	93			
44	RX130	R5F51306BGFN	PLQP0080K*	94			
45	RX130	R5F51307ADFN	PLQP0080K*	95			
46	RX130	R5F51307AGFN	PLQP0080K*	96			
47	RX130	R5F51308ADFN	PLQP0080K*	97			
48	RX130	R5F51308AGFN	PLQP0080K*	98			
49	RX130	R5F51305ADFP	PLQP0100K*	99			
50	RX130	R5F51305AGFP	PLQP0100K*	100			